Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

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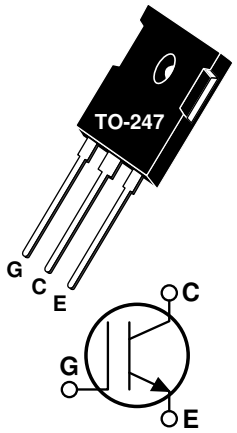
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

APT20GF120BR

1200V 32A

Fast IGBT



The Fast IGBT is a new generation of high voltage power IGBTs. Using Non-Punch Through Technology the Fast IGBT offers superior ruggedness, fast switching speed and low Collector-Emitter On voltage.

- **Low Forward Voltage Drop**
- **High Freq. Switching to 20KHz**
- **Low Tail Current**
- **Ultra Low Leakage Current**
- **Avalanche Rated**
- **RBSOA and SCSOA Rated**

MAXIMUM RATINGS All Ratings: T_C = 25°C unless otherwise specified.

Symbol	Parameter	APT20GF120BR	UNIT
V_{CES}	Collector-Emitter Voltage	1200	Volts
V_{CGR}	Collector-Gate Voltage (R_{GE} = 20KΩ)	1200	
V_{GE}	Gate-Emitter Voltage	±20	
I_{C1}	Continuous Collector Current @ T_C = 25°C	32	Amps
I_{C2}	Continuous Collector Current @ T_C = 90°C	20	
I_{CM}	Pulsed Collector Current ① @ T_C = 25°C	64	
I_{LM}	RBSOA Clamped Inductive Load Current @ R_g = 11Ω T_C = 125°C	40	
E_{AS}	Single Pulse Avalanche Energy ②	22	mJ
P_D	Total Power Dissipation	200	Watts
T_J,T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T_L	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{CES}	Collector-Emitter Breakdown Voltage (V_{GE} = 0V, I_C = 0.8mA)	1200			Volts
$V_{GE}(TH)$	Gate Threshold Voltage (V_{CE} = V_{GE}, I_C = 350µA, T_j = 25°C)	4.5	5.5	6.5	
$V_{CE}(ON)$	Collector-Emitter On Voltage (V_{GE} = 15V, I_C = 15A, T_j = 25°C)		2.7	3.2	
	Collector-Emitter On Voltage (V_{GE} = 15V, I_C = 15A, T_j = 125°C)		3.3	3.9	
I_{CES}	Collector Cut-off Current (V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 25°C)			0.8	mA
	Collector Cut-off Current (V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 125°C)			5.0	
I_{GES}	Gate-Emitter Leakage Current (V_{GE} = ±20V, V_{CE} = 0V)			±100	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

USA 405 S.W. Columbia Street Bend, Oregon 97702-1035 Phone: (541) 382-8028 FAX: (541) 388-0364

EUROPE Chemin de Magret F-33700 Merignac - France Phone: (33) 5 57 92 15 15 FAX: (33) 5 56 47 97 61

052-6214 Rev B 11-2000

DYNAMIC CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{ies}	Input Capacitance	**Capacitance** V_{GE} = 0V, V_{CE} = 25V, f = 1 MHz		1050	1210	pF
C_{oes}	Output Capacitance			100	150	
C_{res}	Reverse Transfer Capacitance			63	110	
Q_g	Total Gate Charge ③	**Gate Charge** V_{GE} = 15V, V_{CC} = 0.5V_{CES}, I_C = I_{C2}		95	140	nC
Q_{ge}	Gate-Emitter Charge			13	20	
Q_{gc}	Gate-Collector ("Miller") Charge			62	90	
$t_d(on)$	Turn-on Delay Time	**Resistive Switching (25°C)** V_{GE} = 15V, V_{CC} = 0.5V_{CES}, I_C = I_{C2}, R_G = 10Ω		15	30	ns
t_r	Rise Time			67	130	
$t_d(off)$	Turn-off Delay Time			92	140	
t_f	Fall Time			93	190	
$t_d(on)$	Turn-on Delay Time	**Inductive Switching (150°C)** V_{CLAMP}(Peak) = 0.66V_{CES}, V_{GE} = 15V, I_C = I_{C2}, R_G = 10Ω, T_J = +150°C		17	34	ns
t_r	Rise Time			30	60	
$t_d(off)$	Turn-off Delay Time			105	160	
t_f	Fall Time			71	140	
E_{on}	Turn-on Switching Energy			1.3	3.0	mJ
E_{off}	Turn-off Switching Energy			1.5	3.0	
E_{ts}	Total Switching Losses			2.7	5.0	
$t_d(on)$	Turn-on Delay Time	**Inductive Switching (25°C)** V_{CLAMP}(Peak) = 0.66V_{CES}, V_{GE} = 15V, I_C = I_{C2}, R_G = 10Ω, T_J = +25°C		17	30	ns
t_r	Rise Time			35	70	
$t_d(off)$	Turn-off Delay Time			93	140	
t_f	Fall Time			70	140	
E_{ts}	Total Switching Losses			2.4	5.0	mJ
gfe	Forward Transconductance	V_{CE} = 20V, I_C = I_{C2}		12		S

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\Theta JC}$	Junction to Case			0.63	°C/W
$R_{\Theta JA}$	Junction to Ambient			40	
W_T	Package Weight		0.22		oz
			6.1		gm
Torque	Mounting Torque (using a 6-32 or 3mm Binding Head Machine Screw)			10	lb•in
				1.1	N•m

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② I_C = I_{C2}, R_{GE} = 25Ω, L = 110µH, T_j = 25°C

③ See MIL-STD-750 Method 3471

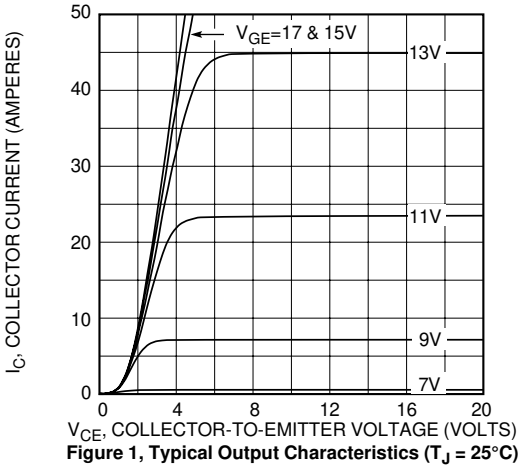


Figure 1, Typical Output Characteristics (T_J = 25°C)

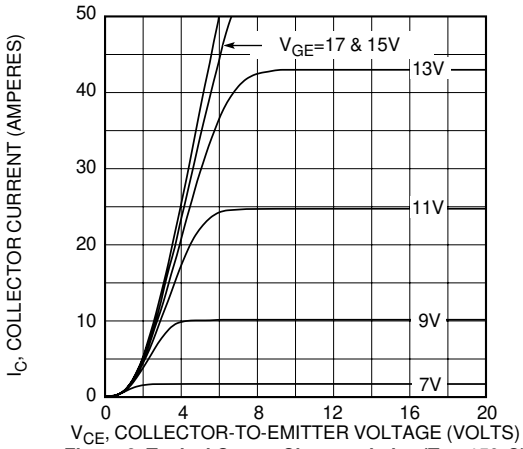


Figure 2, Typical Output Characteristics (T_J = 150°C)

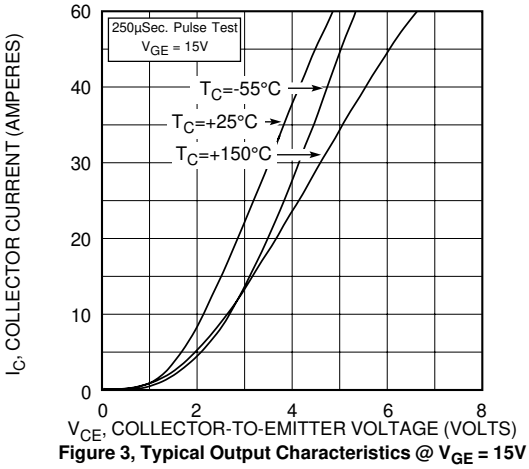


Figure 3, Typical Output Characteristics @ V_{GE} = 15V

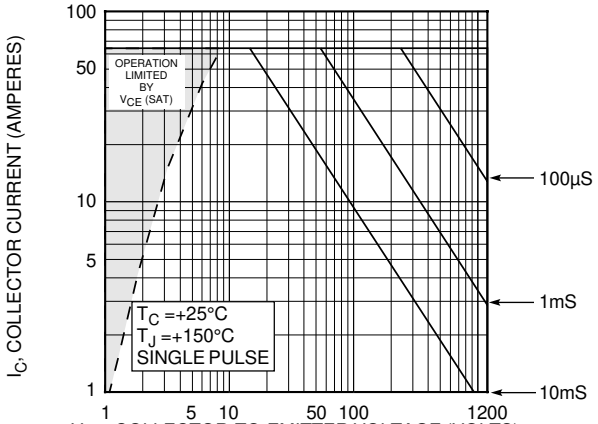


Figure 4, Maximum Forward Safe Operating Area

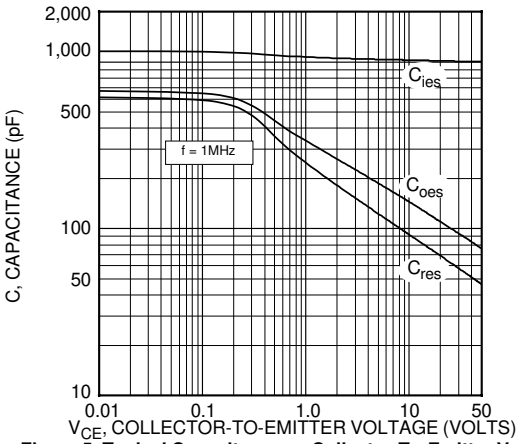


Figure 5, Typical Capacitance vs Collector-To-Emitter Voltage

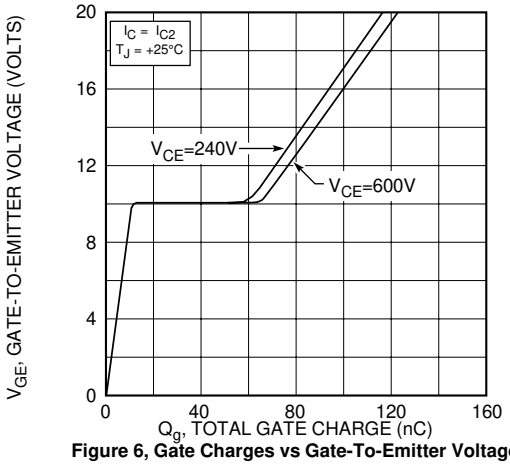


Figure 6, Gate Charges vs Gate-To-Emitter Voltage

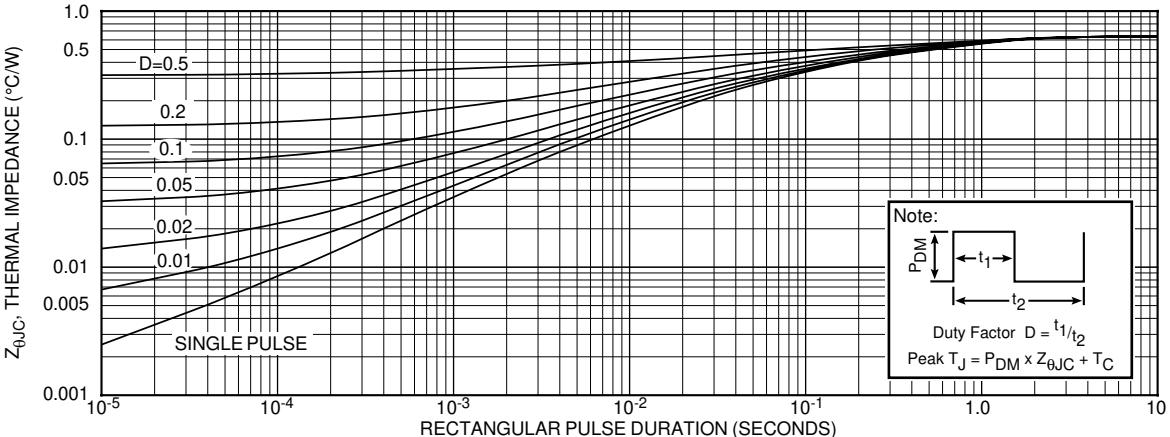


Figure 7, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

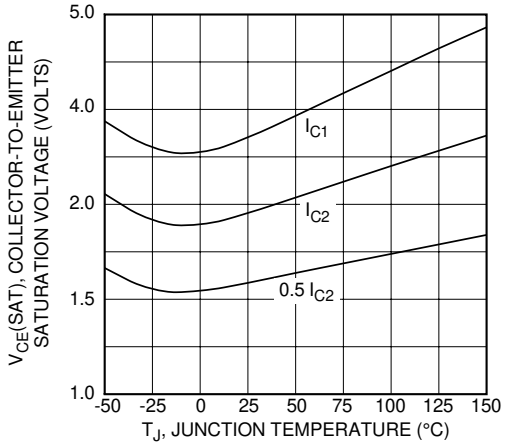


Figure 8, Typical V_{CE}(SAT) Voltage vs Junction Temperature

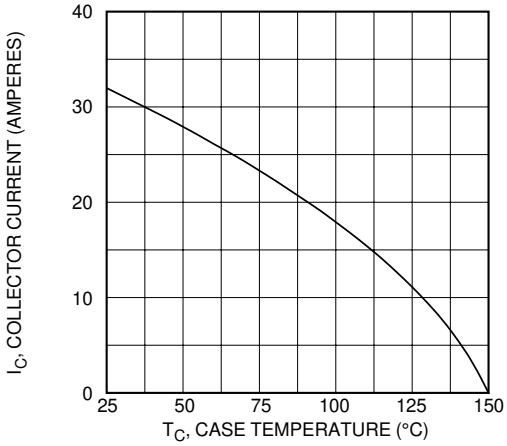


Figure 9, Maximum Collector Current vs Case Temperature

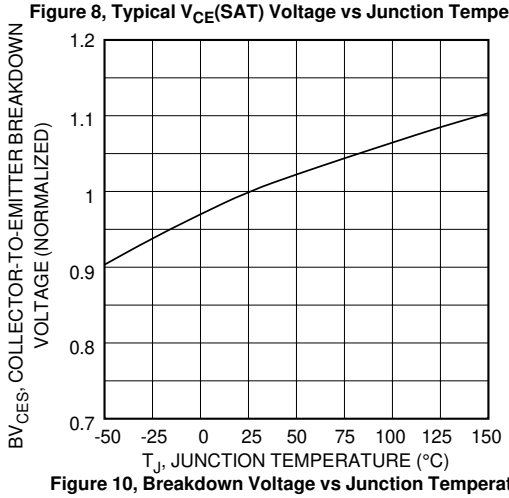


Figure 10, Breakdown Voltage vs Junction Temperature

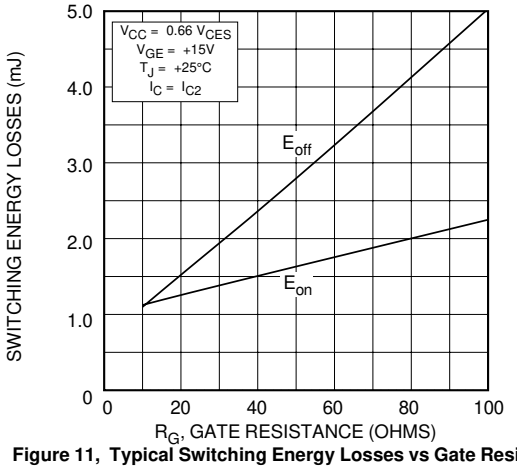


Figure 11, Typical Switching Energy Losses vs Gate Resistance

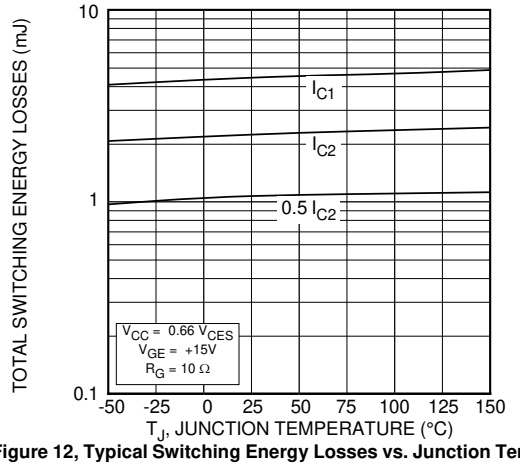


Figure 12, Typical Switching Energy Losses vs. Junction Temperature

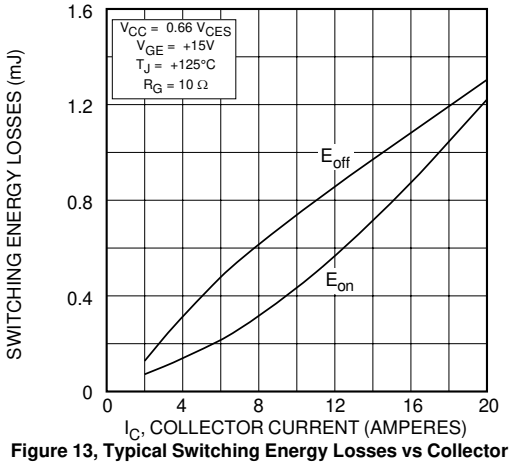


Figure 13, Typical Switching Energy Losses vs Collector Current

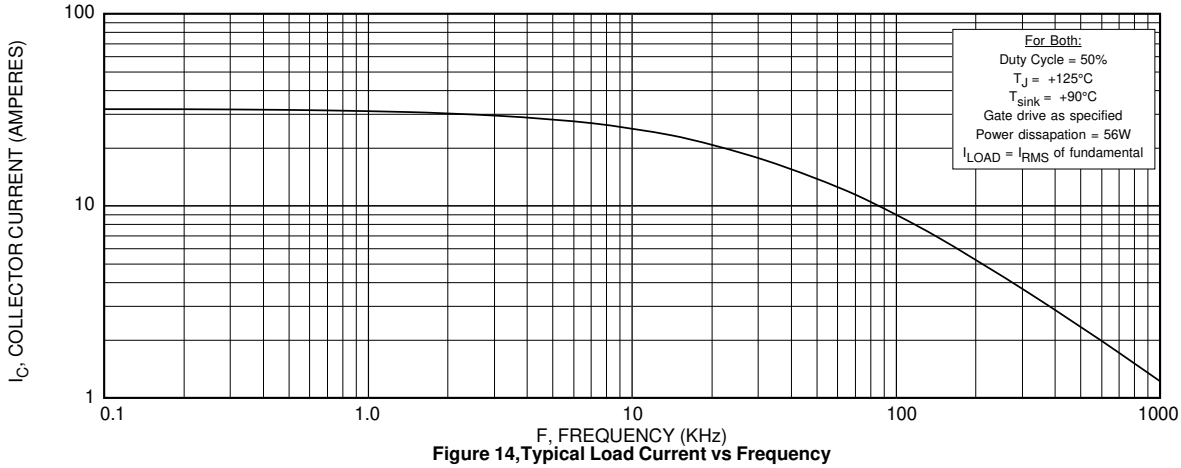


Figure 14,Typical Load Current vs Frequency

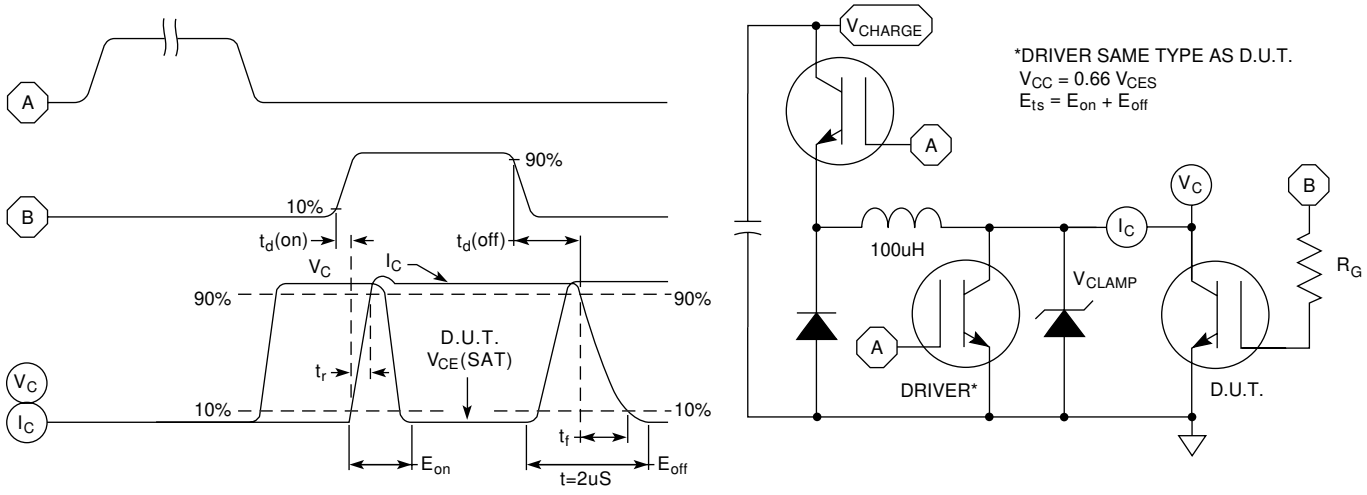


Figure 15, Switching Loss Test Circuit and Waveforms

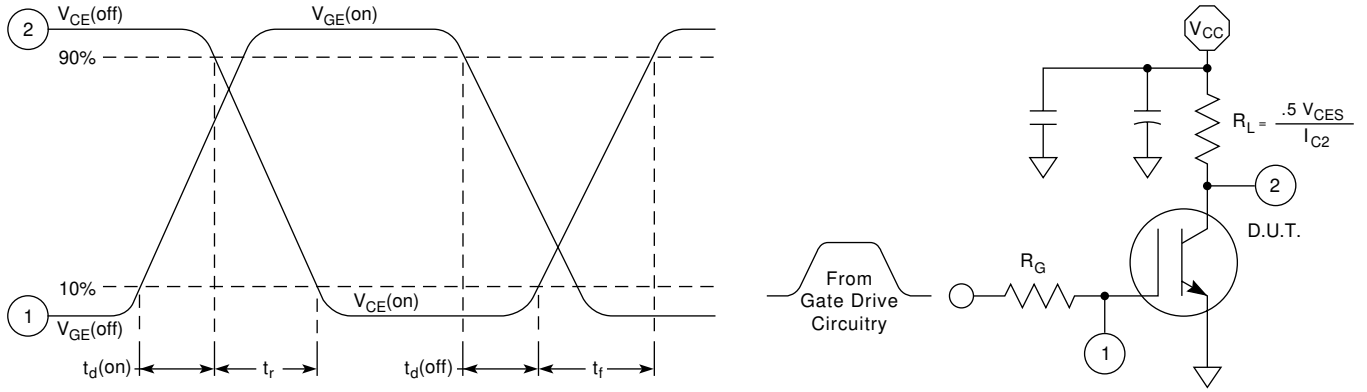
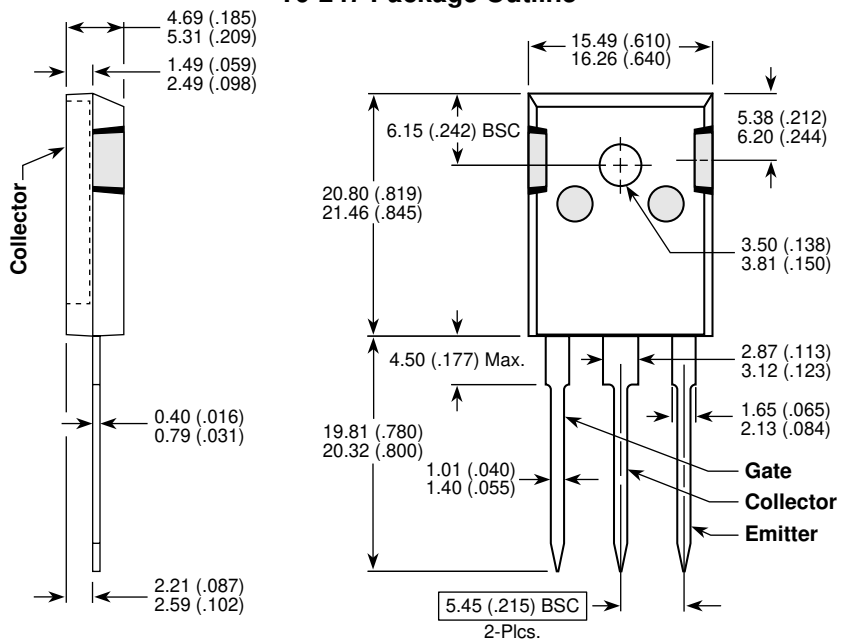


Figure 16, Resistive Switching Time Test Circuit and Waveforms

T0-247 Package Outline



Dimensions in Millimeters and (Inches)